Hierarchical InGaN Nanowires for High-Efficiency Solar Water Splitting

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Solar water splitting has become a promising way to alleviate supply instability of solar energy by directly storing energy in the form of hydrogen fuel. Maximizing efficiency for photoelectrochemical (PEC) water splitting requires (i) a tunable bandgap that captures the solar spectrum, (ii) an energy band edge that spans the water redox potential, and (iii) high quantum efficiency [1,2]. Although a variety of materials such as Si, Ta_3N_5 , and BiVO₄ have been studied as photoelectrodes, most materials have not yet fulfilled these requirements. For instance, the onset potential of Si and Ta_3N_5 is too large so charge carriers cannot be sufficiently generated under sun illumination and BiVO₄ has a wide 2.4 eV bandgap that limits the efficient utilization of the solar spectrum [1,2]. The InGaN ternary system is an optimal photoelectrode for efficient solar hydrogen production (Fig. 1a). The bandgap (Eg) of InGaN is direct and tunable from 3.4 (GaN) to 0.65 eV (InN) for indium compositions up to ~50%, allowing optimal use of the entire solar spectrum ($E_g \approx 1.7$ eV), which could potentially enable a solar-to-hydrogen efficiency over 25% [1,2,3]. However, creating high-performance InGaN photoelectrodes is difficult as In-rich crystals are highly strained causing phase segregation and subsequent performance degradation.

Here we show low-dimensional nanostructures accommodate crystalline InGaN nanowires capable of enhanced water splitting performance (highest reported value of 10.9 mA/cm² at 1.23 V versus reversible hydrogen electrode (RHE)) and photoluminescence (a single emission peak at 720 nm) [2]. Using plasma-assisted molecular beam epitaxy (MBE), highly crystalline InGaN can be grown as one dimensional (1D) nanostructures. This allows high quantum efficiency with a larger surface area for PEC reaction [2,4]. Cross-sectional electron microscopy of InGaN/Si (Fig.1b, c) reveals that the crystalline InGaN nanowires have an approximate height of ~700 nm tall and diameter of ~200 nm wide which extend atop a polycrystalline growth layer on the Si substrate. The low-dimensional geometry not only allows high In concentrations, but also provides more catalytically active surface area. IrO₂ co-catalysts with a size of 1-2 nm were uniformly loaded on the InGaN surface (Fig. 1c) to further enhance performance. The current-potential (J-V) curves of IrO₂ (Fig.1d) show that the photocurrent density of IrO₂/InGaN reaches 10.9 mA/cm² at 1.23 V versus RHE due to the lower onset potential of the IrO₂ co-catalyst combined with the sufficient InGaN bandgap of ~1.7 eV. The maximum applied bias photon-to-current efficiency (ABPE) of the IrO₂/InGaN photoanode calculated from the J-V curve is 3.6%, which is the highest among those of previously reported photoelectrodes [2].

InGaN crystals can also be grown with hierarchical order that spans the nano- to atomic- scale through 1D lithographic templating (Fig. 2a-c). Cross-sectional electron microscopy shows the periodic GaN nanowalls (width ~500 nm, height ~1 um, spacing ~400 nm) that template confined InGaN growth (Fig. 2a). InGaN grows as triangular prisms atop each nanowall (Fig. 2a) because the polar facet (001) has a faster growth rate than that of the semi-polar (101) and non-polar (100) facet sidewalls. It is also interesting that a sharply faceted single crystal InGaN nanoridge (~50 nm width) forms along the top of each nanowalls (Fig. 2c). In confined geometry heteroepitaxy, increased In incorporation can occur due to

the onset of 'strain relaxed growth' [4]. An energy dispersive x-ray (EDS) map shows that the InGaN nanoridge is composed of Ga, In, and N without phase segregation (Fig. 2b). Atomic resolution dark field STEM reveals a lattice spacing of 2.95Å (Fig. 2e) and confirms an In-rich InGaN crystal (InN spacing is 3.06 Å). Lastly, the highly ordered 1D InGaN provides strong photoluminescence emission (Fig. 2d).

References:

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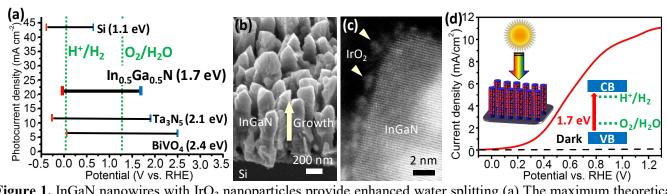


Figure 1. InGaN nanowires with IrO₂ nanoparticles provide enhanced water splitting (a) The maximum theoretical photocurrent densities of different photoanode materials under AM 1.5G 1-sun illumination. (b) Side-view SEM reveals epitaxial growth of IrO₂-InGaN nanowires across a silicon wafer. (c) A cross-sectional high-angle annular dark field (HAADF) STEM image shows the ~1-2 nm IrO₂ nanoparticles adsorbed to the InGaN surface. (d) J-V curves of InGaN and IrO₂/InGaN in 0.5 M H₂SO₄ under AM 1.5G 1-sun illumination.

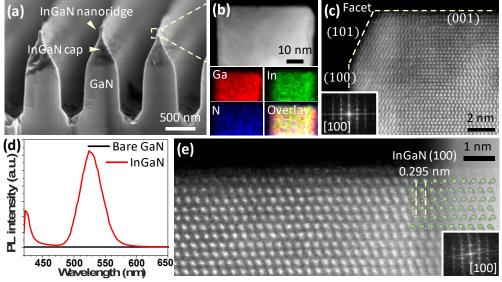


Figure 2. Single crystal 1D InGaN nanoridge grown on GaN wall (a) Side-view SEM (b) HAADF STEM image on cross-sectional InGaN nanowalls and simultaneous STEM EDS spectroscopic mapping showing the grown InGaN tip primarily comprised of Ga (red), In (blue), and N (green). (c) High resolution HAADF STEM on the sharply-faceted InGaN nanoridge in c indicating highly single crystalline. (d) Room temperature micro-PL of InGaN nanowalls and reference GaN wall. (e) Atomic resolution HAADF STEM on the termination of the InGaN tip in c indicating the lattice constant that is consistent with InGaN.